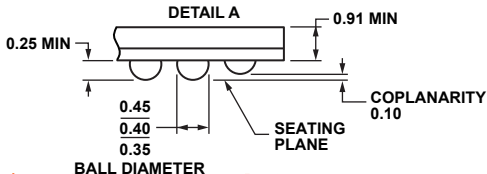
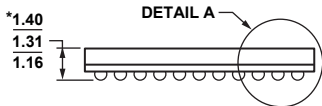
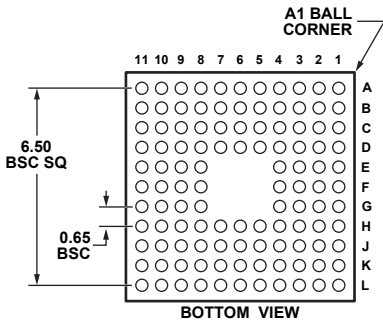
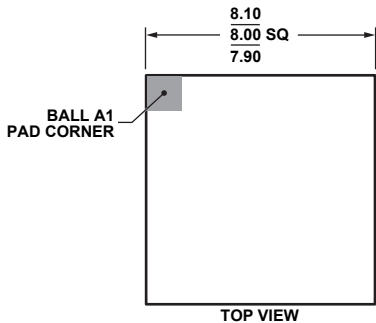


**112-Ball Chip Scale Package Ball Grid Array [CSP\_BGA]  
(BC-112-1)**

Dimensions shown in millimeters



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\*COMPLIANT TO JEDEC STANDARDS MO-225  
WITH THE EXCEPTION TO PACKAGE HEIGHT.